Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.0033				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0046				
Q <sub>g</sub> typ. (nC)	90				
I <sub>D</sub> (A) <sup>d</sup>	-36				
Configuration	Single				

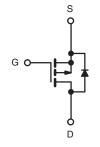
#### **FEATURES**

- TrenchFET® power MOSFET
- 100% R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



## **APPLICATIONS**

- · Adaptor switch
- · High current load switch
- Notebook



P-Channel MOSFET

ORDERING INFORMATION			
Package	SO-8		
Lead (Pb)-free and halogen-free	Si4497DY-T1-GE3		

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> =	25 °C, unless other	wise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-30	V	
Gate-source voltage	$V_{GS}$	± 20	v		
	T <sub>C</sub> = 25 °C		-36		
Continuous drain surrent (T = 150 °C)	T <sub>C</sub> = 70 °C	Ι, Γ	-29		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	-24.8 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	-19.2 <sup>a, b</sup>		
Pulsed drain current	I <sub>DM</sub>	-70	A		
Continuous source dusin diada aurunnt	T <sub>C</sub> = 25 °C	,	-6.5		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-2.9 <sup>a, b</sup>		
Avalanche current  Single-pulse avalanche energy  L = 0.1 mH		I <sub>AS</sub>	-30		
		E <sub>AS</sub>	45	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum power dissipation	T <sub>C</sub> = 70 °C		5	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C	1	2.2 a, b		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient a, c	t ≤ 10 s	$R_{thJA}$	29	35	°C/W	
Maximum junction-to-foot	Steady state	R <sub>th,IF</sub>	13	16	- C/W	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 80 °C/W
- d. Based on T<sub>C</sub> = 25 °C

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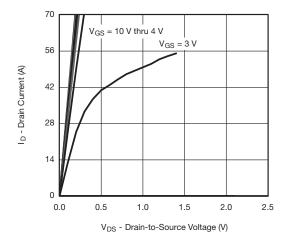
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•	•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-26	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	5.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1	-	-2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μА	
Zero gate voltage drain current		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-5		
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α	
<b>5</b>	_	$V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	-	0.0027	0.0033	+	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$	-	0.0038	0.0046	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -20 \text{ A}$	-	75	-	S	
Dynamic <sup>b</sup>			l	l			
Input capacitance	C <sub>iss</sub>		-	9685	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	995	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	995	-		
	Qg	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -20 A	-	190	285	1	
Total gate charge			-	90	135		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -20 \text{ A}$	-	27.5	-	nC	
Gate-drain charge	Q <sub>ad</sub>		-	26.5	-	†	
Gate resistance	R <sub>q</sub>	f = 1 MHz	0.5	2.3	4.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	19	35		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_{I} = 1.5 \Omega$	-	13	25	1	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	115	200		
Fall time	t <sub>f</sub>		-	25	50	1	
Turn-on delay time	t <sub>d(on)</sub>		-	100	180	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_{L} = 1.5 \Omega$	-	75	150		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -10 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	100	180		
Fall time	t <sub>f</sub>		-	42	80		
Drain-Source Body Diode Characteris	stics		l	l		1	
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	_	_	-36		
Pulse diode forward current	I <sub>SM</sub>	<u> </u>	-	-	-70	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -3 A, V <sub>GS</sub> = 0 V	-	-0.7	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	5 / GO -	-	31	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -10 A, di/dt = 100 A/μs,	-	23	45	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_{J} = 25 \text{ °C}$		13	-	1	
Reverse recovery rise time	t <sub>b</sub>		_	18	-	ns	

#### Notes

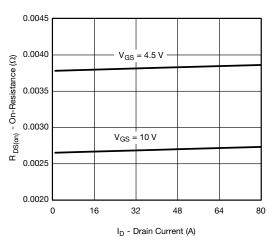
- a. Pulse test; pulse width  $\leq 300 \,\mu\text{s}$ , duty cycle  $\leq 2\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

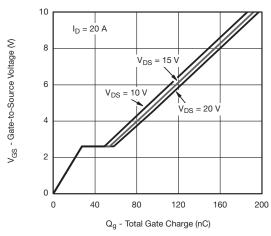




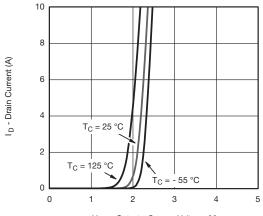
## **Output Characteristics**



## On-Resistance vs. Drain Current

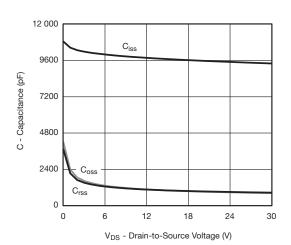


Gate Charge

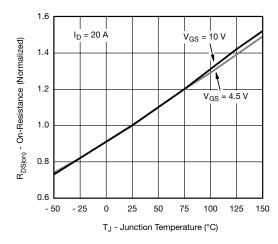


V<sub>GS</sub> - Gate-to-Source Voltage (V)

## **Transfer Characteristics**

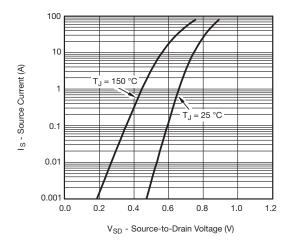


Capacitance

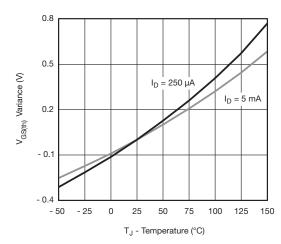


On-Resistance vs. Junction Temperature

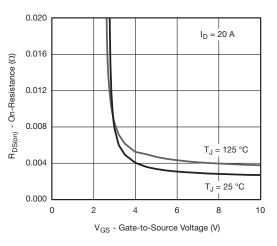




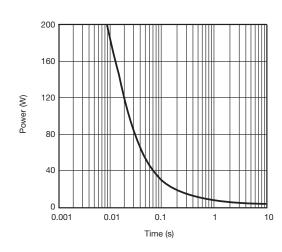
#### Source-Drain Diode Forward Voltage



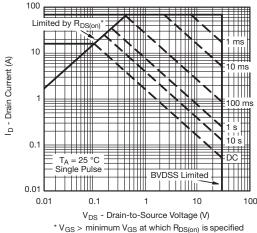
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

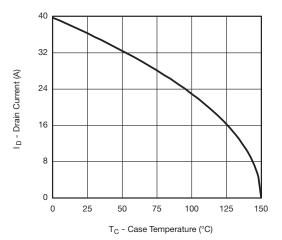


Single Pulse Power, Junction-to-Ambient

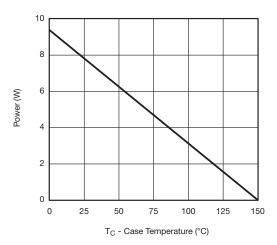


Safe Operating Area

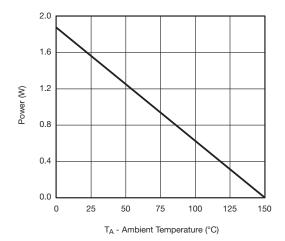




## Current Derating a





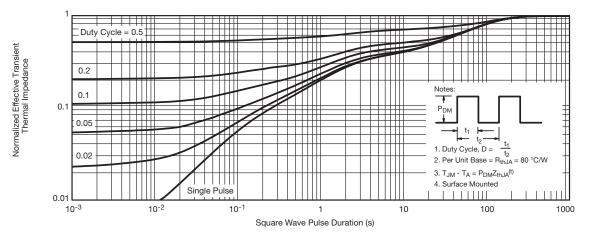


Power Derating, Junction-to-Ambient

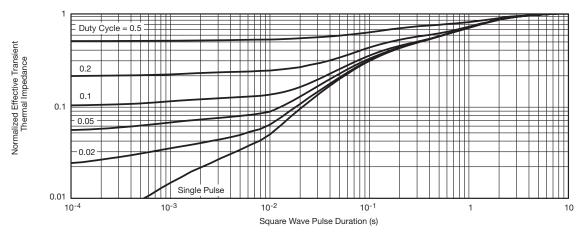
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



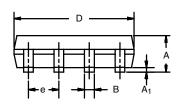
Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHE		HES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



## **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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